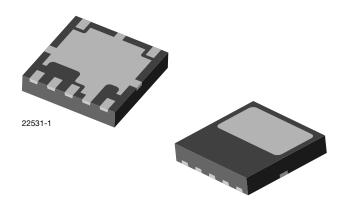


## **IR Detector for Mid Range Proximity Sensor**



#### **DESCRIPTION**

The TSSP57P38 is a compact infrared detector module for proximity sensing application. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

The length of the detector's output pulse varies in proportion to the amount of light reflected from the object being detected.

#### **ORDERING CODE**

#### Taping:

TSSP57P38TT1 - top view taped TSSP57P38TT2 - top view taped

#### **FEATURES**

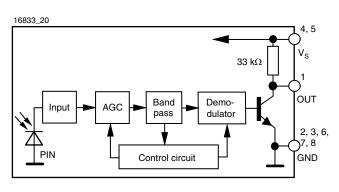
- · Height of 0.8 mm
- Up to 2 m for proximity sensing
- Receives 38 kHz modulated signal
- 940 nm peak wavelength
- Photo detector and preamplifier in one package
- Low supply current
- · Shielding against EMI
- · Visible light is suppressed by IR filter
- Insensitive to supply voltage ripple and noise
- Supply voltage: 2.5 V to 5.5 V
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

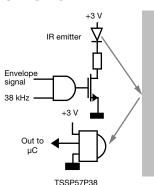
- Object approach detection for activation of displays and user consoles, signaling of alarms, etc.
- Simple gesture controls
- Differentiation of car arrival, static, car departure in parking lots
- · Reflective sensors for toilet flush
- Navigational sensor for robotics

PARTS TABLE		
Carrier frequency	38 kHz	TSSP57P38
Package		Belobog
Pinning		1 = OUT, 2, 3, 6, 7, 8 = GND, 4, 5 = V <sub>S</sub>
Dimensions (mm)		3.95 W x 3.95 H x 0.8 D
Mounting		SMD
Application		Proximity sensors

#### **BLOCK DIAGRAM**



#### **PROXIMITY SENSING**







RoHS

HALOGEN FREE

<u>GREEN</u> (5-2008)



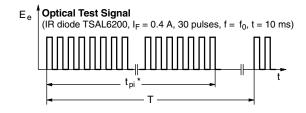
ABSOLUTE MAXIMUM F	RATINGS			
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		Vs	-0.3 to +6	V
Supply current		Is	5	mA
Output voltage		Vo	-0.3 to (V <sub>S</sub> + 0.3)	V
Output current		I <sub>O</sub>	5	mA
Junction temperature		T <sub>j</sub>	100	°C
Storage temperature range		T <sub>stg</sub>	-25 to +85	°C
Operating temperature range		T <sub>amb</sub>	-25 to +85	°C
Power consumption	T <sub>amb</sub> ≤ 85 °C	P <sub>tot</sub>	10	mW

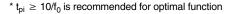
#### Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

ELECTRICAL AND OP	FICAL CHARACTERISTICS	(T <sub>amb</sub> = 25 °	°C, unless o	therwise s	pecified)	
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		V <sub>S</sub>	2.5	-	5.5	V
Complete accompany	$V_{S} = 5 \text{ V}, E_{e} = 0$	I <sub>SD</sub>	0.55	0.7	0.9	mA
Supply current	$E_v = 40 \text{ klx, sunlight}$	I <sub>SH</sub>	-	0.8	-	mA
Receiving distance	Direct line of sight, IR diode TSAL6200, I <sub>F</sub> = 250 mA, test signal see fig. 1	d	-	40	-	m
Output voltage low	$I_{OSL}$ = 0.5 mA, $E_{e}$ = 0.7 mW/m <sup>2</sup> , test signal see fig. 1	V <sub>OSL</sub>	-	-	100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_{o,}$ test signal see fig. 1	E <sub>e min.</sub>	-	0.2	0.4	mW/m²
Maximum irradiance	$t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o,$ test signal see fig. 1	E <sub>e max.</sub>	50	-	-	W/m <sup>2</sup>
Directivity	Angle of half receiving distance	Ψ1/2	-	± 75	-	deg

## TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)





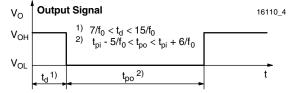


Fig. 1 - Output Active Low

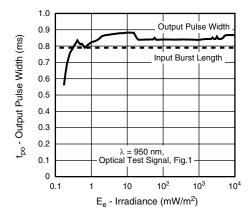


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

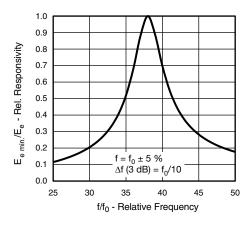


Fig. 3 - Frequency Dependance of Responsivity

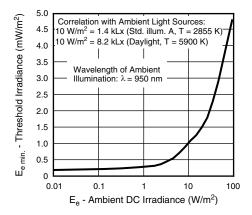


Fig. 4 - Sensitivity in Bright Ambient

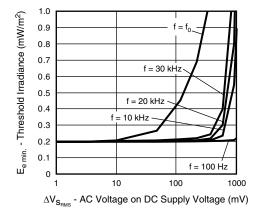


Fig. 5 - Sensitivity vs. Supply Voltage Disturbances

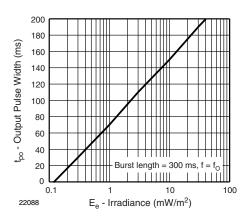


Fig. 6 - Output Pulse Width vs. Irradiance

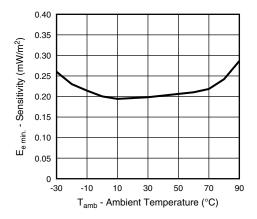


Fig. 7 - Sensitivity vs. Ambient Temperature

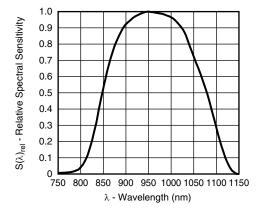


Fig. 8 - Relative Spectral Sensitivity vs. Wavelength

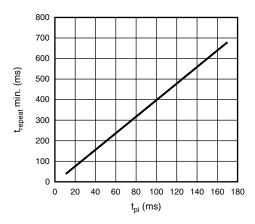


Fig. 9 - Max. Rate of Bursts

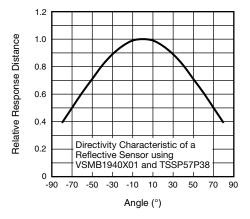


Fig. 10 - Angle Characteristic

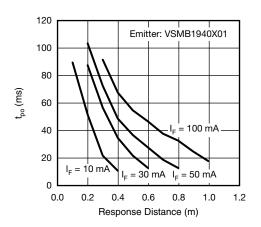


Fig. 11 - t<sub>po</sub> vs. Distance

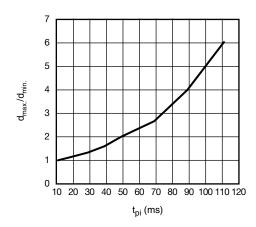
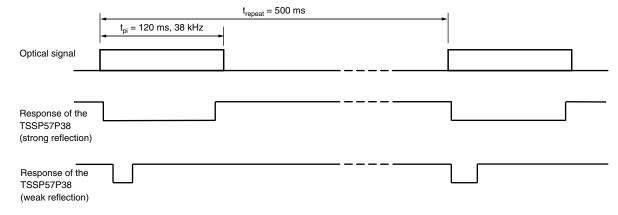


Fig. 12 - Dynamic Range of Sensor vs.  $t_{pi}$ 

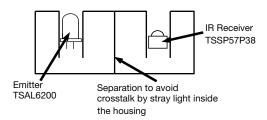
The typical application of the TSSP57P38 is a reflective sensor with analog information contained in its output. Such a sensor is evaluating the time required by the AGC to suppress a quasi continuous signal. The time required to suppress such a signal is longer when the signal is strong than when the signal is weak, resulting in a pulse length corresponding to the distance of an object from the sensor. This kind of analog information can be evaluated by a microcontroller. The absolute amount of reflected light depends much on the environment and is not evaluated. Only sudden changes of the amount of reflected light, and therefore changes in the pulse width, are evaluated using this application.

### Example of a signal pattern:





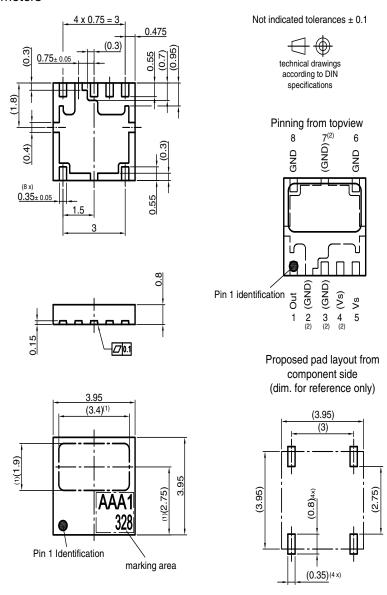
#### Example for a sensor hardware:



There should be no common window in front of the emitter and receiver in order to avoid crosstalk by guided light through the window.

The logarithmic characteristic of the AGC in the TSSP57P38 results in an almost linear relationship between distance and pulse width. Ambient light has also some impact to the pulse width of this kind of sensor, making the pulse shorter.

#### **PACKAGE DIMENSIONS** in millimeters



Drawing-No.: 6.550-5315.01-4 Issue: 2: 12.02.14

#### Notes

<sup>(1)</sup> Optically effective area

<sup>(2)</sup> Pins connected internally. It is not necessary to connect externally.



#### **ASSEMBLY INSTRUCTIONS**

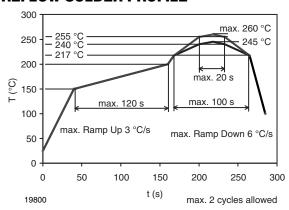
#### **Reflow Soldering**

- Reflow soldering must be done within 168 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

#### **Manual Soldering**

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

## VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



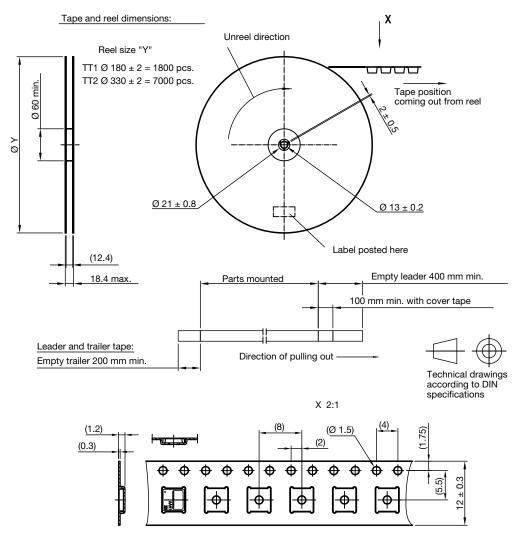
ORDERING INFORMATION			
ORDERING CODE	PACKAGING	VOLUME (1)	REMARKS
TSSP57P38TT1	Tana and roal	MOQ: 1800 pcs	3.95 mm x 3.95 mm x 0.75 mm
TSSP57P38TT2	Tape and reel	MOQ: 7000 pcs	3.95 Hill X 3.95 Hill X 0.75 Hill

#### Note

(1) MOQ: minimum order quantity



### TAPING VERSION TSSP57P38 DIMENSIONS in millimeters



Drawing-No.: 9.700-5347.01-4

Issue: 1; 14.11.11

Not indicated tolerances ± 0.1

#### LABEL

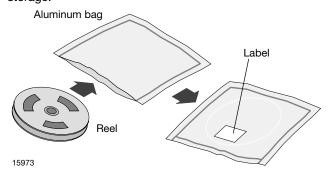
#### Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxx+	Company logo
Long bar code top	Туре	Length
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
Short bar code bottom	Туре	Length
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

#### **DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



#### **FINAL PACKING**

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

#### RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC  $^{\tiny{(8)}}$  standard J-STD-020 level 3 label is included on all dry bags.



#### www.vishay.com

## Vishay Semiconductors

## LEVEL Caution 3 This bag contains MOISTURE-SENSITIVE DEVICES 1. Calculated shelf life in sealed bag: 12 months at $<\!40^{\circ}\mathrm{C}$ and $<\!90\%$ relative humidity (RH) 3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be a) Mounted within: $\frac{168}{\text{lf blank, see adjacent bar code label}}$ hours of factory conditions $\le\!30^\circ\text{C}/60^\circ\!\!\text{RH, or}$ b) Stored per J-STD-033 4. Devices require bake, before mounting, if: a) Humidity Indicator Card reads > 10% for level 2a - 5a devices or $>\!\!60\%$ for level 2 devices when read at 23±5°C b) 3a or 3b are not met 5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure If blank, see adjacent bar code label Note: Level and body temperature defined by IPC/JEDEC J-STD-020 22650

EIA JEDEC standard J-STD-020 level 3 label is included on all dry bags

#### **ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

# VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

### **BAR CODE PRODUCT LABEL** (Example)



2217



# Tape and Reel Standards for Surface-Mount IR Receiver Modules

Vishay Semiconductor surface-mount IR receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

#### **PACKAGING**

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Type
- Group
- Tape code, normally part of type name
- Production code
- Quantity

#### MISSING COMPONENTS

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

Tensile strength of the tape: > 15 N

#### **NUMBER OF COMPONENTS**

A. Panhead: quantity per reel:

TT, top view package, 1190 pcs

TR, side view package, 1120 pcs

B. Heimdall: quantity per reel:

TT, top view package, 2200 pcs

TR, side view package, 2300 pcs

C. Heimdall without lens: quantity per reel:

WTT, top view package, 2200 pcs

WTR, side view package, 2300 pcs

D. Belobog: quantity per reel:

TT1, top view package, 1800 pcs

TT2, top view package, 7000 pcs

E. Belobog with shield: quantity per reel:

TT1, top view package, 1500 pcs

TT2, top view package, 5000 pcs

F. Minimold DF1P: quantity per reel:

DF1P, 1100 pcs

G. TVCastSMD TR1: quantity per reel:

TR1, side view package, 2200 pcs

#### ORDER DESIGNATION

The type designation of the device is extended by TT or TT1 for top view or TR for side view.

#### Example:

TSOP6238TR (reel packing)

TSOP75238TR (reel packing)

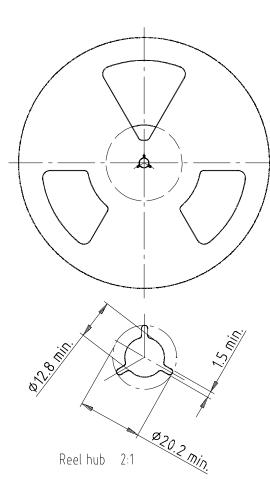
TSOP75338WTT (reel packing)

TSOP57438TT1 (reel packing)

TSOP57238HTT1 (reel packing)

TSOP39438TR1 (reel packing)

## REEL DIMENSIONS FOR PANHEAD, HEIMDALL, AND TVCASTSMD TR in millimeters



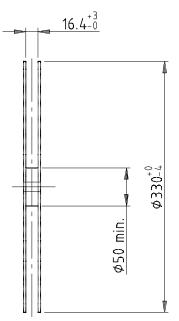
Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734

#### Note

• The body structure of the reel can vary



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16

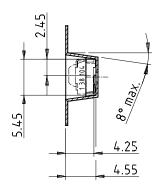


technical drawings according to DIN specifications

## TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

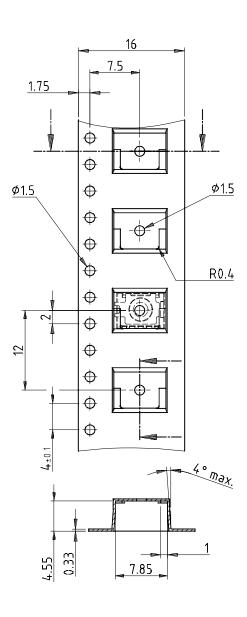
A. Panhead (TSOP36...TT, TSSP....TT, TSOP6...TT, TSOP16...TT, TSOP96...TT)





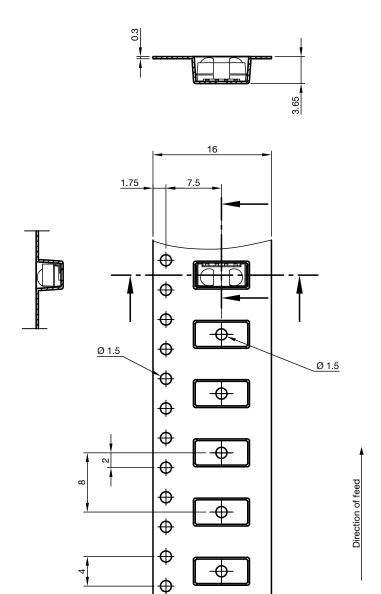
Drawing-No.: 9.700-5259.01-4 Issue: 1; 05.09.01

16584



## TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

B. Heimdall (TSOP75...TT, TSOP77...TT, TSSP77...TT, TSOP15...TT, TSOP95...TT)



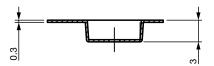
Drawing-No.: 9.700-5338.01-4

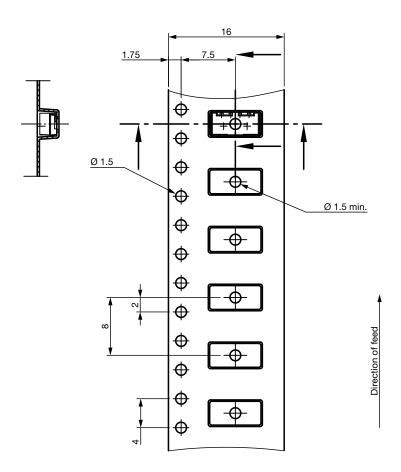
Issue: 4; 12.06.13

technical drawings according to DIN specifications

## TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTT, TSOP77...WTT, TSSP77...WTT, TSOP15...WTT, TSOP95...WTT)





Drawing-No.: 9.700-5341.01-4

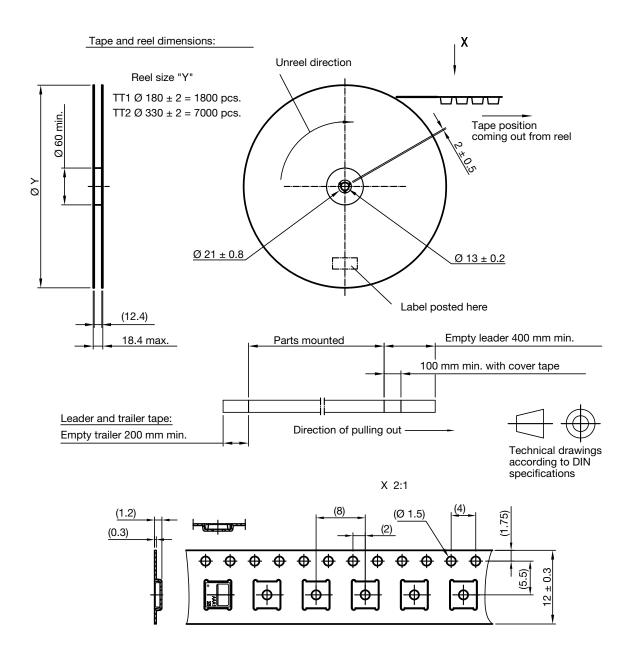
Issue: 3; 06.10.15

technical drawings according to DIN specifications



## TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

D. Belobog (TSOP37...TT1, TSOP37...TT2, TSOP57...TT1, TSOP57...TT2, TSOP17...TT1, TSOP17...TT1, TSOP97...TT2)



Drawing-No.: 9.700-5347.01-4

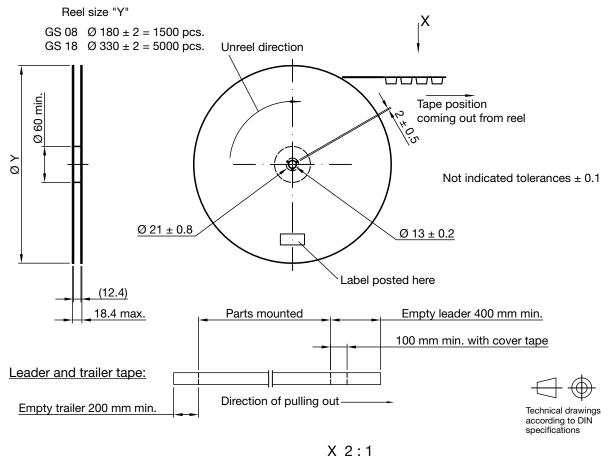
Issue: 1; 14.11.11

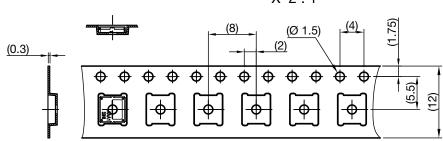
Not indicated tolerances ± 0.1

## TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

E. Belobog with shield (TSOP37...HTT1, TSOP37...HTT2, TSOP57...HTT1, TSOP57...HTT2, TSOP17...HTT1, TSOP17...HTT1, TSOP97...HTT2)

#### Tape and Reel dimensions:





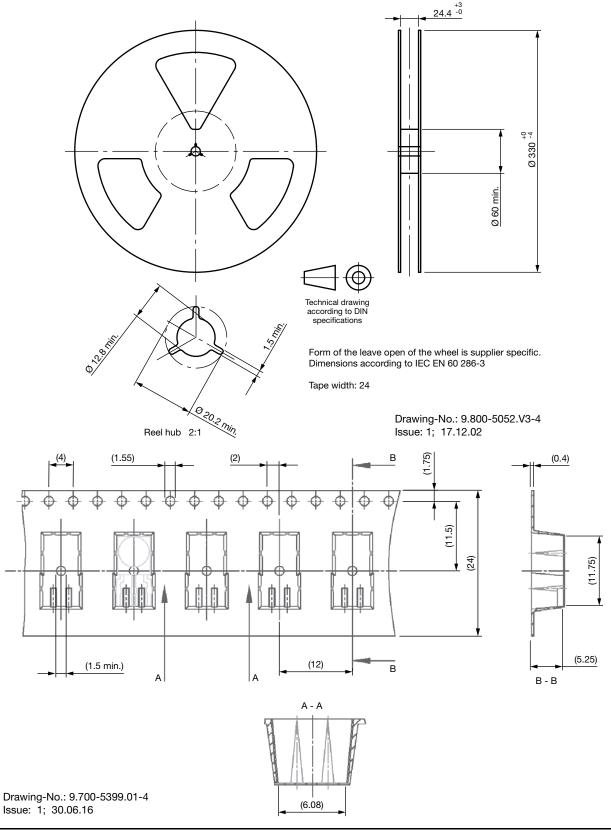
Drawing-No.: 9.700-5380.01-4

Issue: 1; 28.10.13

Reel dimensions and tape

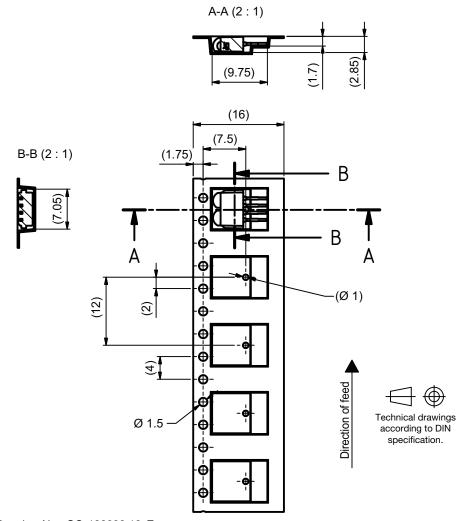
## TAPING VERSION TSOP..DF1P (SIDE VIEW) DIMENSIONS in millimeters

F. Minimold DF1P (TSOP33...DF1P, TSOP53...DF1P, TSOP13...DF1P, TSOP93...DF1P)



## TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

G. TVCastSMD TR1 (TSOP59...TR1, TSOP39...TR1, TSOP19...TR1, TSOP99...TR1)

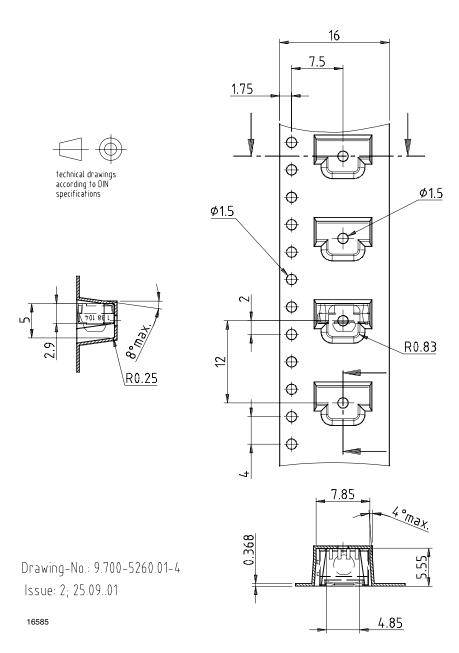


Drawing-No.: GO-100220.10\_Z

Issue B: 08.02.17

## TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

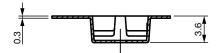
A. Panhead (TSOP36...TR, TSSP6...TR, TSOP6...TR, TSOP16...TR, TSOP96...TR)

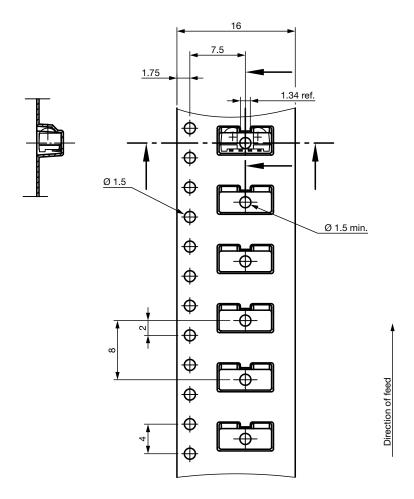




## TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

B. Heimdall (TSSP7...., TSOP75...TR, TSOP77...TR, TSOP15...TR, TSOP95...TR)





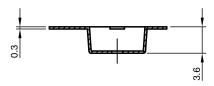
Drawing-No.: 9.700-5337.01-4

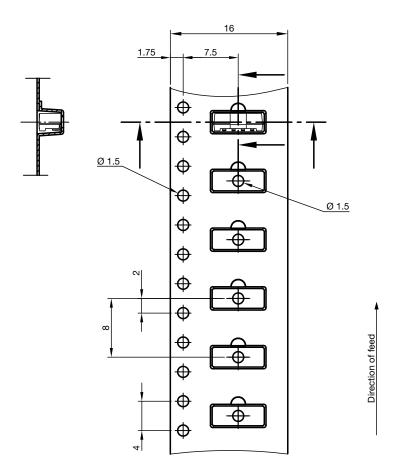
Issue: 2; 06.10.15

technical drawings according to DIN specifications

## TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTR, TSOP77...WTR, TSSP...WTR, TSOP15...WTR, TSOP95...WTR)





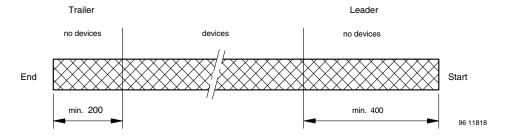
technical drawings according to DIN specifications

Drawing-No.: 9.700-5342.01-4

Issue: 2; 12.06.13



### **LEADER AND TRAILER DIMENSIONS** in millimeters



### **COVER TAPE REEL STRENGTH**

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min.  $\pm$  10 mm/min. 165° to 180° peel angle

#### **LABEL**

#### Standard bar code labels for finished goods

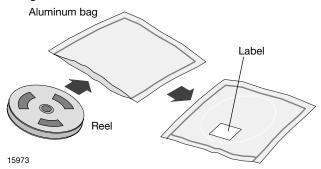
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE TOP	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17



#### **DRY PACKAGING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



### **RECOMMENDED METHOD OF STORAGE**

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

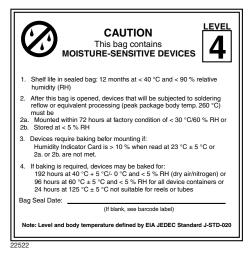
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC  $^{\!0}\!\!\!\!\!^{^{^{\phantom{0}}}}$  standard JSTD-020 level 4 label is included on all dry bags.



EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

#### **ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

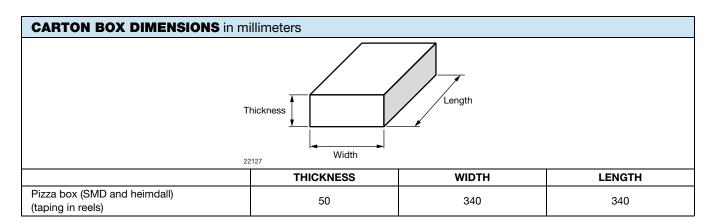
# VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



### **OUTER PACKAGING**

The sealed reel is packed into a pizza box.





## **Legal Disclaimer Notice**

Vishay

## **Disclaimer**

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